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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/623,666	07/21/2003	Claes Bjorkman	7090/P2 & 107262.202US1	5063

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EXAMINER

SONG, SARAH U

ART UNIT

PAPER NUMBER

2874

DATE MAILED: 10/19/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)	
	10/623,666	BJORKMAN ET AL.	
	Examiner Sarah Song	Art Unit 2874	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) Responsive to communication(s) filed on 27 July 2005.
- 2a) This action is FINAL. 2b) This action is non-final.
- 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) Claim(s) 1-6,8-10 and 17-28 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) Claim(s) _____ is/are allowed.
- 6) Claim(s) 1-6,8-10 and 17-28 is/are rejected.
- 7) Claim(s) _____ is/are objected to.
- 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) The specification is objected to by the Examiner.
- 10) The drawing(s) filed on 26 February 2004 and 27 July 2005 is/are: a) accepted or b) objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) All b) Some * c) None of:
1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) Notice of References Cited (PTO-892)
- 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date 1103.0705.
- 4) Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.
- 5) Notice of Informal Patent Application (PTO-152)
- 6) Other: _____.

DETAILED ACTION

1. Applicant's communication filed on July 27, 2005 has been carefully considered and placed of record in the file. Claims 1, 6, 9, 10 and 23 have been amended. Claims 1-6, 8-10 and 17-28 are pending.

Information Disclosure Statement

2. The prior art documents submitted by the applicant in the Information Disclosure Statement filed on November 5, 2003 and July 27, 2005 have all been considered and made of record (note the attached copy of form PTO-1449).

Drawings

3. The replacement drawing sheets received on July 27, 2005 are accepted.

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

5. **Claims 1-6, 8-10 and 17-28 are rejected under 35 U.S.C. 103(a) as being unpatentable over Delwala (U.S. Patent 6,658,173 previously relied upon) in view of Johnson et al. (U.S. Patent Application Publication 2002/0181825 previously relied upon), Nakamura (U.S. Patent 6,449,411 previously relied upon) and Fitzgerald (U.S. Patent 6,680,495 newly cited).**

6. Regarding claim 1, Delwala discloses an article of manufacture comprising an optical ready substrate 152 made of a first semiconductor layer 102, an insulating layer 104 on top of the

first semiconductor layer, and a second semiconductor layer 160 on top of the insulating layer, wherein the second semiconductor layer has a top surface and is laterally divided into two regions including a first region and a second region (see Figure 1), the top surface of the first region being of a quality that is sufficient to permit microelectronic circuitry to be fabricated therein (see paragraph spanning columns 12 and 13) and said second region including an optical signal distribution circuit formed therein, said optical signal distribution circuit made up of interconnected semiconductor photonic elements (i.e. waveguide devices) interconnected by an optical waveguide (e.g. 161).

7. Delwala does not expressly disclose said optical signal distribution circuit to be designed to provide signals to the microelectronic circuit to be fabricated in the first region of the second semiconductor layer at said later time.

8. Johnson et al. discloses an article of manufacture comprising an optical substrate made of semiconductor layers and comprising a first region and a second regions, wherein the first region being of a quality sufficient to permit microelectronic circuitry 3813 to be fabricated therein and said second region including an optical signal distribution circuit fabricated therein, said optical signal distribution circuit made up of interconnected semiconductor photonic elements 3815 and designed to provide signals to the microelectronic circuit 3813 to be fabricated in the first region (see Paragraph [0139]).

9. Delwala and Johnson et al. are analogous art as pertaining to hybrid integrated circuits.

10. It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide the optical signal distribution circuit of Delwala such that it was

designed to provide signals to the microelectronic circuit to be fabricated in the first region of the second semiconductor layer, as shown by Johnson et al.

11. One of ordinary skill in the art would have been motivated to design the optical distribution circuit of Delwala such that it was designed to provide signals to the microelectronic circuit in the first region in order to provide high speed on-chip communications as taught by Johnson et al. (Paragraph [0141]).

12. Delwala does not expressly disclose the waveguide for carrying an optical signal characterized by a wavelength of about 850 nanometers or less. However, it is noted that the functional recitation that the waveguide is for carrying an optical signal characterized by a wavelength of about 850 nm or less has not been given patentable weight because it is narrative in form.

13. Nevertheless, Nakamura discloses planar waveguides which comprise a germanium doped silica core and a silica cladding formed on a silicon substrate (column 5, lines 21-28) and which are capable of carrying an optical signal characterized by a wavelength of about 850 nm or less and therefore meets the claimed limitation.

14. Nakamura is analogous art as pertaining to planar lightwave circuits.

15. It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide silica based waveguide, which is capable of carrying an optical signal characterized by a wavelength of 850 nm or less, since Nakamura discloses that the silica based waveguides provide ease of integration (column 3, lines 34-39).

16. Additionally, Delwala also does not expressly disclose the first region into which fabrication of microelectronic circuitry has not yet begun. As noted above, Delwala discloses the

first regions comprising the microelectronic circuitry (i.e. fabrication already begun). It is noted that the method of forming the device is not germane to the issue of patentability of the device itself.

17. However, Fitzgerald discloses a method of forming an article of manufacture comprising an optical ready substrate made of a first semiconductor layer 308, an insulating layer 310, and a second semiconductor layer 306 or 312, wherein the second semiconductor layer is laterally divided into two regions including a first region and a second region, the first region into which fabrication of microelectronic circuitry has not yet begun (see Figures 6a and 6b) and being of quality that is sufficient to permit microelectronic circuitry to be fabricated therein at a later time (as evidenced by the fabrication of the CMOS circuitry shown in Figure 6c).

18. Fitzgerald is analogous art as pertaining to integrated circuits.

19. Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to manufacture the article of manufacture as claimed in order to take advantage of the thermal budget to eliminate sharp energy band discontinuities for certain devices as taught by Fitzgerald (column 6, lines 41-47).

20. Regarding claim 17, the second semiconductor layer 160 comprises silicon.

21. Regarding claims 18-28, as noted above, the waveguide includes a core material of silica doped with GeO₂, and a silica cladding; and the topside (top surface) of the semiconductor chip (substrate) comprises silicon (Figures 3-4 of Delwala).

22. Regarding claims 2-4, resultantly, the semiconductor photonic elements of the optical signal distribution circuit include an output elements couple to the optical waveguide for delivering signals carried by the waveguides to the microelectronic circuitry; the output element

is an optical detector which converts optical signals to electrical signals; and the optical signal distribution network is an optical clock signal distribution network (Paragraphs [0138]-[0139]).

23. Regarding claim 5, the first semiconductor layer 102 comprises silicon.
24. Regarding claim 6, the insulating layer 104 comprises an oxide of silicon.
25. Regarding claim 8, the combination of the first semiconductor layer, the insulating layer and the second semiconductor layer is an SOI structure 152.
26. Regarding claim 9, Delwala does not expressly disclose the second region of the second semiconductor layer to be thicker than the first region of the second semiconductor layer.

However, it is known in the art to adjust the thickness of layers of an optical circuit in order to optimize waveguiding properties. Therefore, it would have been obvious to one having ordinary skill in the art to provide the second region of the second semiconductor layer thicker than the first region in order to ensure optimal mode confinement to the waveguides. Furthermore, it is noted that since applicant has not disclosed that the feature solves any stated problem or is for any particular purpose and it appears that the invention would perform equally well with a thicker second region.

27. Regarding claim 10, the top surface of the first region is of a quality that is sufficient to permit CMOS circuitry to be formed therein at a later time(see paragraph spanning columns 10 and 11; note also paragraph 17 above).

Response to Arguments

28. Applicant's arguments with respect to claims 1-6, 8-10 and 17-28 have been considered but are moot in view of the new ground(s) of rejection.

29. Regarding Applicant's argument pertaining to the order of manufacture and the thermal considerations of such order of manufacture, the order of manufacture or method of forming a device is given patentable weight in a device claim. However, as noted in the rejections above, Fitzgerald is additionally relied upon as disclosing an article of manufacture and method of manufacture wherein the substrate comprises the claimed regions and wherein the microelectronic circuitry is fabricated at a later time. Fitzgerald also notes the thermal considerations in column 6, lines 41-47.

Conclusion

30. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Sarah Song whose telephone number is 571-272-2359. The examiner can normally be reached on M-Th 7:30am - 6:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Rodney Bovernick can be reached on 571-272-2344. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).



Sarah Song
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